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A control signal WE is input to the gate of the transistor **1209**. As for each of the switch **1203** and the switch **1204**, a conduction state or a non-conduction state between the first terminal and the second terminal is selected by the control signal RD which is different from the control signal WE. When the first terminal and the second terminal of one of the switches are in the conduction state, the first terminal and the second terminal of the other of the switches are in the non-conduction state.

A signal corresponding to data retained in the circuit **1201** is input to the other of the source and the drain of the transistor **1209**. FIG. **19** illustrates an example in which a signal output from the circuit **1201** is input to the other of the source and the drain of the transistor **1209**. The logic value of a signal output from the second terminal of the switch **1203** (the other of the source and the drain of the transistor **1213**) is inverted by the logic element **1206**, and the inverted signal is input to the circuit **1201** through the circuit **1220**.

In the example of FIG. **19**, a signal output from the second terminal of the switch **1203** (the other of the source and the drain of the transistor **1213**) is input to the circuit **1201** through the logic element **1206** and the circuit **1220**; however, one embodiment of the present invention is not limited thereto. The signal output from the second terminal of the switch **1203** (the other of the source and the drain of the transistor **1213**) may be input to the circuit **1201** without its logic value being inverted. For example, in the case where the circuit **1201** includes a node in which a signal obtained by inversion of the logic value of a signal input from the input terminal is retained, the signal output from the second terminal of the switch **1203** (the other of the source and the drain of the transistor **1213**) can be input to the node.

In FIG. **19**, the transistors included in the memory element **1200** except for the transistor **1209** can each be a transistor in which a channel is formed in a film formed using a semiconductor other than an oxide semiconductor or in the substrate **1190**. For example, the transistor can be a transistor whose channel is formed in a silicon film or a silicon substrate. Alternatively, all the transistors in the memory element **1200** may be a transistor in which a channel is formed in an oxide semiconductor. Further alternatively, in the memory element **1200**, a transistor in which a channel is formed in an oxide semiconductor may be included besides the transistor **1209**, and a transistor in which a channel is formed in a film formed using a semiconductor other than an oxide semiconductor or in the substrate **1190** can be used for the rest of the transistors.

As the circuit **1201** in FIG. **19**, for example, a flip-flop circuit can be used. As the logic element **1206**, for example, an inverter or a clocked inverter can be used.

In a period during which the memory element **1200** is not supplied with the power supply voltage, the semiconductor device of one embodiment of the present invention can retain data stored in the circuit **1201** by the capacitor **1208** which is provided in the circuit **1202**.

The off-state current of a transistor in which a channel is formed in an oxide semiconductor is extremely low. For example, the off-state current of a transistor in which a channel is formed in an oxide semiconductor is significantly lower than that of a transistor in which a channel is formed in silicon having crystallinity. Thus, when the transistor is used as the transistor **1209**, a signal held in the capacitor **1208** is retained for a long time also in a period during which the power supply voltage is not supplied to the memory element **1200**. The memory element **1200** can accordingly retain the stored content (data) also in a period during which the supply of the power supply voltage is stopped.

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Since the above-described memory element performs pre-charge operation with the switch **1203** and the switch **1204**, the time required for the circuit **1201** to retain original data again after the supply of the power supply voltage is restarted can be shortened.

In the circuit **1202**, a signal retained by the capacitor **1208** is input to the gate of the transistor **1210**. Therefore, after supply of the power supply voltage to the memory element **1200** is restarted, the transistor **1210** is brought into the on state or the off state depending on the signal retained by the capacitor **1208**, and a signal corresponding to the state can be read from the circuit **1202**. Consequently, an original signal can be accurately read even when a potential corresponding to the signal retained by the capacitor **1208** varies to some degree.

By applying the above-described memory element **1200** to a memory device such as a register or a cache memory included in a processor, data in the memory device can be prevented from being lost owing to the stop of the supply of the power supply voltage. Furthermore, shortly after the supply of the power supply voltage is restarted, the memory device can be returned to the same state as that before the power supply is stopped. Therefore, the power supply can be stopped even for a short time in the processor or one or a plurality of logic circuits included in the processor, resulting in lower power consumption.

Although the memory element **1200** is used in a CPU, the memory element **1200** can also be used in an LSI such as a digital signal processor (DSP), a custom LSI, or a programmable logic device (PLD), and a radio frequency (RF) device.

<Electronic Device>

The semiconductor device of one embodiment of the present invention can be used for display devices, personal computers, or image reproducing devices provided with recording media (typically, devices which reproduce the content of recording media such as digital versatile discs (DVD) and have displays for displaying the reproduced images). Other examples of electronic devices that can be equipped with the semiconductor device of one embodiment of the present invention are mobile phones, game machines including portable game consoles, portable data terminals, e-book readers, cameras such as video cameras and digital still cameras, goggle-type displays (head mounted displays), navigation systems, audio reproducing devices (e.g., car audio systems and digital audio players), copiers, facsimiles, printers, multifunction printers, automated teller machines (ATM), and vending machines. FIGS. **20A** to **20F** illustrate specific examples of these electronic devices.

FIG. **20A** illustrates a portable game console including a housing **901**, a housing **902**, a display portion **903**, a display portion **904**, a microphone **905**, a speaker **906**, an operation key **907**, a stylus **908**, and the like. Although the portable game console in FIG. **20A** has the two display portions **903** and **904**, the number of display portions included in a portable game console is not limited to this.

FIG. **20B** illustrates a portable data terminal including a housing **911**, a housing **912**, a display portion **913**, a display portion **914**, a joint **915**, an operation key **916**, and the like. The display portion **913** is provided in the housing **911**, and the display portion **914** is provided in the housing **912**. The housing **911** and the housing **912** are connected to each other with the joint **915**, and the angle between the housing **911** and the housing **912** can be changed with the joint **915**. An image on the display portion **913** may be switched in accordance with the angle at the joint **915** between the housing **911** and the housing **912**. A display device with a